

# **Bi-directional ESD Protection Diode**

#### **FEATURES**

- Meet IEC61000-4-2 (ESD) ±15kV (air), ±8kV (contact)
- Meet IEC61000-4-4 (EFT) rating. 40A (5/50µs)
- 100W peak pulse power per line (tp=8/20µs)
- Protects one bi-directional I/O line
- Working Voltage: 5V
- Packing code with suffix "G" means green compound (halogen free)





DFN1006 (0402)



#### **MECHANICAL DATA**

- Case: DFN1006 (0402)
- Molding compound flammability rating: UL 94V-0
- Terminal: Gold plated, solderable per

MIL-STD-750, method 2026

- High temperature soldering guaranteed : 260°C/10s
- Weight: 0.5 mg (approximately)
- Marking code: M

#### **APPLICATIONS**

- -Cell Phone Handsets and Accessories
- -Notebooks, Desktops, and Servers
- -Keypads, Side Keys, LCD Displays
- -Portable Instrumentation
- -Touch Panel



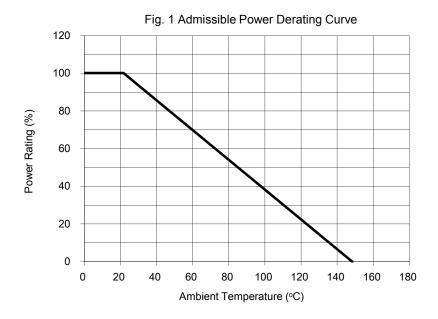
MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS (T <sub>A</sub> =25°C unless otherwise noted)				
PARAMETER	SYMBOL	VALUE	UNIT	
Peak Pulse Power (tp=8/20µs waveform)	$P_{PP}$	100	W	
ESD per IEC 61000-4-2 (Air)	$V_{ESD}$	± 15	K//	
ESD per IEC 61000-4-2 (Contact)	V ESD	± 8	- KV	
Junction and Storage Temperature Range	$T_J,T_STG$	-55 to +150	°C	

PARA	METER	SYMBOL	MIN	MAX	UNIT
Stand-Off Voltage		$V_{WM}$	-	5	V
Reverse Breakdown Voltage	$I_R = 1 \text{ mA}$	$V_{(BR)}$	6	-	V
Reverse Leakage Current	$V_{RWM} = 5 V$	I <sub>R</sub>	-	1	μA
Clamping Voltage	I <sub>PP</sub> = 1 A	V <sub>C</sub>	-	12.5	V
Clamping Voltage	I <sub>PP</sub> = 2 A		-	20	
Junction Capacitance	V <sub>R</sub> = 0 V , f = 1.0 MHz	CJ	1	0	pF



#### **RATINGS AND CHARACTERISTICS CURVES**

(T<sub>A</sub>=25°C unless otherwise noted)



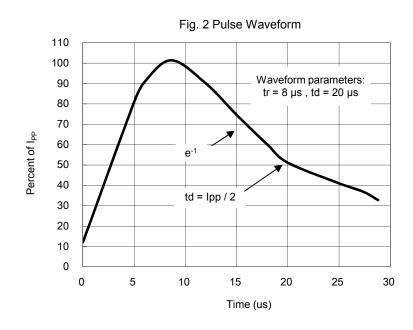
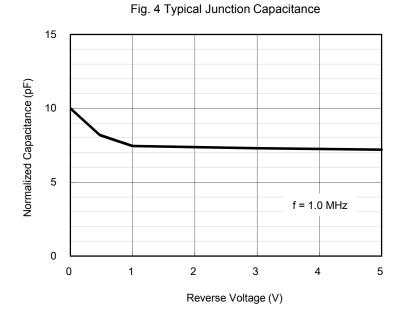


Fig. 3 Max. Clamping Voltage VS. Peak Pulse Current 25 20 Clamping Voltage, Vc (V) 15 10 Waveform parameters:  $tr = 8 \mu s$ ,  $td = 20 \mu s$ 5 0 0 1 2 3 5 Peak Pulse Current, Ipp (A)



#### **Applications Information**

- $\diamondsuit$  Designed to protect one data, I/O, or power supply line
- Designed to protect sensitive electronics from damage or latch-up due to ESD
- ♦ Designed to replace multilayer varistors (MLVs) in portable applications
- Features large cross-sectional area junctions for conducting, high transient currents
- ♦ Offers superior electrical characteristics such as lower clamping voltage and no device degradation when compared to MLV
- ♦ The combination of small size and high ESD surge capability makes them ideal for use in portable applications

#### **Circuit Board Layout Recommendations**

Good circuit board layout is critical for suppresion of ESD induced transients

- Place the ESD Protection Diode near the input terminals or connectors to restrict transient
- ♦ Minimize the path length between the ESD Protection Diode and the protected line
- $\diamondsuit$  Minimize all conductive loops including power and ground loops
- $\diamondsuit$  The ESD transient return path to ground should be kept as short as possible
- ♦ Never run critical signals near board edges
- ♦ Use ground planes whenever possible

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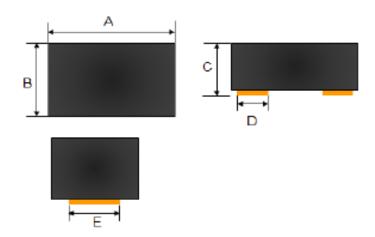


ORDERING INFORMATION					
PART NO.	PART NO. SUFFIX (Note 1)	PACKING CODE	PACKING CODE SUFFIX	PACKAGE	PACKING
TESDQ5V0	-XX	RJ	G	DFN1006 (0402)	10K / 7" Reel

Note 1: Part No. Suffix "-xx " would be used for special requirement

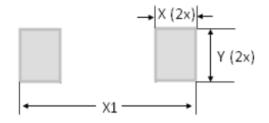
EXAMPLE					
PREFERRED P/N	PART NO.	PART NO. SUFFIX	PACKING CODE	PACKING CODE SUFFIX	DESCRIPTION
TESDQ5V0 RJG	TESDQ5V0		RJ	G	Multiple manufacture source Green compound
TESDQ5V0-E0 RJG	TESDQ5V0	-E0	RJ	G	Define manufacture source Green compound

# PACKAGE OUTLINE DIMENSION DFN1006 (0402)



DIM.	Unit (mm)		Unit (inch)	
DIIVI.	Min	Max	Min	Max
Α	0.95	1.05	0.037	0.041
В	0.55	0.65	0.022	0.026
С	0.45	0.55	0.018	0.022
D	0.30 TYP.		0.012 TYP.	
Е	0.50 TYP.		0.020	TYP.

# **SUGGEST PAD LAYOUT**



DIM.	Unit (mm)	Unit (inch)	
DIIVI.	TYP.	TYP.	
Х	0.354	0.014	
X1	1.110	0.044	
Υ	0.354	0.014	





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